ABSOLUTE MAXIMUM RATINGS

(Valtages referenced to CND)		Contir
(Voltages referenced to GND)		
V+		Peak (
V	44V to +0.3V	109
V+ to V	0.3V to +44V	Contir
COM_, IN_ (Note 1)	(V0.3V) to $(V++0.3V)$	Plas
NC_, NO_ (Note 2)		Nar
MAX4631E	(V+ - 36V) to (V- + 36V)	CEF
MAX4632E	(V+ - 25V) to (V- + 25V)	Opera
MAX4633E	(V+ - 36V) to (V- + 36V)	MA
NC_, NO_ to COM_		MA
MAX4631E	36V to +36V	MA
MAX4632E	25V to +25V	Storag
MAX4633E	36V to +36V	Lead

Continuous Current into Any Terminal±30r Peak Current into Any Terminal (pulsed at 1ms,	mΑ
10% duty cycle)±50i	mΑ
Continuous Power Dissipation ($T_A = +70^{\circ}C$) (Note 2)	
Plastic DIP (derate 10.53mW/°C above +70°C)842r	nW
Narrow SO (derate 8.70mW/°C above +70°C)696r	nW
CERDIP (derate 10.00mW/°C above +70°C)842r	nW
Operating Temperature Ranges	
MAX463_C_E0°C to +70)°C
MAX463_E_E40°C to +85	5°C
MAX463_M_E55°C to +125	5°C
Storage Temperature Range65°C to +150)°C
Lead Temperature (soldering, 10sec)+300)°C

- Note 1: COM_ and IN_ pins are not fault protected. Signals on COM_ to IN_ exceeding V+ or V- are clamped by internal diodes. Limit forward diode current to maximum current rating.
- Note 2: NC_ and NO_ pins are fault protected (see *Electrical Characteristics*). With power applied to V+ or V-, signals on NC_ or NO_ exceeding ±25V (MAX4632) or ±36V (MAX4631/MAX4633) may damage the device. With V+ = V- = 0, signals on NC_ or NO_ exceeding ±40V may damage the device.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—Dual Supplies

(V+ = +15V, V- = -15V, V_{INL} = 0.8V, V_{INH} = 2.4V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 3)

PARAMETER	SYMBOL	COND	ITIONS	TA	MIN	TYP	MAX	UNITS
ANALOG SWITCH	•							•
Fault-Free Analog Signal Range (Note 2)	V _{NO} _, V _{NC} _			C, E, M	V-		V+	V
COM to NO TO NO		101/		+25°C		62	85	
COM_ to NO_ or NC_ On-Resistance	Ron	$V_{COM} = \pm 10V$ $I_{COM} = 1mA$,	C, E			100	Ω
- Chi ricolotanos		ICOIVI_ = IIIII (М			200	
COM_ to NO_ or NC_		10)/		+25°C		3	6	
On-Resistance Match	ΔRon	$V_{COM} = \pm 10V$ $I_{COM} = 1mA$,	C, E			10	Ω
Between Channels (Note 4)		ICON IIIA		М			15	
NO NO COM OF Laborate	INO_ (OFF), INC_ (OFF), ICOM_(OFF)	V _{COM} _ = ±14V, V _{NO} _ or V _{NC} _ = ∓14V		+25°C	-0.5	0.01	0.5	nA
NO_, NC_, COM_ Off-Leakage Current (Note 5)				C, E	-5		5	
Carroni (Note C)				М	-100		100	
COM On Lankage Course		$V_{COM} = \pm 14V$,	+25°C	-0.5	0.01	0.5	
COM_ On-Leakage Current (Note 5)	ICOM_(ON)	V _{NO_} or V _{NC_} = ±14V or floating		C, E	-20		20	nA
(11010-0)				М	-100		100	
FAULT PROTECTION								
Fault-Protected Analog Signal Range (Note 2)	V _{NO_} , V _{NC_}	Applies with power on	MAX4631/ MAX4633	C, E, M	-36		36	V
			MAX4632	C, E, M	-25		25	1 V
		Applies with power off		C, E, M	-40		40	1

ELECTRICAL CHARACTERISTICS—Dual Supplies (continued)

 $(V+=+15V, V-=-15V, V_{INL}=0.8V, V_{INH}=2.4V, T_A=T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$ Typical values are at $T_A=+25^{\circ}C.)$ (Note 3)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP	MAX	UNITS
0011 0 1 1 0		V_{NO} or $V_{NC} = \pm 25V$,	+25°C	-10		10	n /
COM_ Output Leakage Current, Supplies On	ICOM_	no connection to "on" channel	C, E	-200		200	- nA
Supplies Off		(MAX4632 only)	М	-1		1	μΑ
NO SUNO INSTITUTE		V	+25°C	-20		20	nA
NO_ or NC_ Input Leakage Current, Supplies On	I _{NO} _, I _{NC} _	V_{NO} or V_{NC} = ±25V, V_{COM} = ±10V	C, E	-200		200	
		*COW_ = 10 *	М	-10		10	μΑ
NO or NO Input Lookage			+25°C	-20		20	nA
NO_ or NC_ Input Leakage Current, Supplies Off	INO_, INC_	V_{NO} or $V_{NC} = \pm 40V$,	C, E	-200		200	117 (
			М	-10		10	μΑ
COM_ Output Clamp Current,	Ісом	V_{NO} or V_{NC} = +25 V	+25°C	13	18	24	mA
Supplies On	ICON_	V_{NO} or $V_{NC} = -25V$	+25°C	-24	-18	13	1117 \
COM_ Output Clamp Resistance, Supplies On	R _{COM} _	V_{NO} or V_{NC} = ±25V	+25°C		0.5	1	kΩ
LOGIC INPUT							
IN_ Input Logic Voltage High	V _{INH} _		C, E, M	2.4			V
IN_ Input Logic Voltage Low	V _{INL} _		C, E, M			0.8	V
IN_ Input Current Logic	Lana Lana	1 0 0 0 0 0 0 0 0	+25°C	-1	0.03	1	
High or Low	I _{INH_} , I _{INL_}	$V_{IN} = 0.8V \text{ or } 2.4V$	C, E, M	-5		5	μΑ
SWITCH DYNAMIC CHARACTE	RISTICS						•
		$V_{COM} = \pm 10V, R_{L} = 1k\Omega,$ Figure 2	+25°C		100	150	ns
Turn-On Time	ton		C, E,			500	
		1 19410 2	М			600	
		10// 0 11/0	+25°C		50	100	
Turn-Off Time	toff	$V_{COM} = \pm 10V, R_L = 1k\Omega,$ Figure 2	C, E,			400	ns
		1 19410 2	М			500	
Break-Before-Make Time Delay (MAX4632 only)	t _{BBM}	$V_{COM} = \pm 10V$, $R_L = 1k\Omega$, Figure 3	+25°C	10	40		ns
Charge Injection (Note 6)	Q	C _L = 100pF, Figure 4, NO_ = NC_ = GND, R _S = 0	+25°C		5	10	рС
NO_, NC_ Off- Capacitance	C _{NC_(OFF)} , C _{NO_(OFF)}	NO_ = NC_ = GND, f = 1MHz, Figure 5	C, E, M		18		pF
COM_ Off-Capacitance	C _{COM_(OFF)}	COM_ = GND, f = 1MHz, Figure 5	C, E, M		18		рF
COM_ On-Capacitance	C _{COM} (ON)	COM_ = NO_ = NC_ = GND, f = 1MHz, Figure 5	C, E, M		22		pF

ELECTRICAL CHARACTERISTICS—Dual Supplies (continued)

 $(V+ = +15V, V- = -15V, V_{INL} = 0.8V, V_{INH} = 2.4V, T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25$ °C.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP	MAX	UNITS
Off-Isolation (Note 7)	V _{ISO}	$R_L = 50\Omega$, $C_L = 15pF$, $V_{NO} = V_{NC} = 1V_{RMS}$, f = 1MHz, Figure 6	C, E, M		-62		dB
Channel-to-Channel Crosstalk (Note 8)	V _{CT}	$R_L = 50\Omega$, $C_L = 15pF$, $V_{NO} = V_{NC} = 1V_{RMS}$, f = 1MHz, Figure 7	C, E, M		-66		dB
POWER SUPPLY							
Power-Supply Range	V+, V-		C, E, M	±4.5		±18	V
V+ Supply Current	l+	All V _{IN} _ = 0 or 5V, V _{NO} _ or V _{NC} _ = 0	+25°C		230	325	
v+ Supply Current			C, E, M			550	μA
V- Supply Current		All $V_{IN} = 0$ or $5V$,	+25°C		130	200	μΑ
v- Supply Current	-	V_{NO} or $V_{NC} = 0$	C, E, M			300	1 μΑ
GND Supply Current		All V_{IN} = 0 or 15V,	+25°C	-1	0.01	1	
	lovin	V _{NO} _ or V _{NC} _ = 0	C, E, M			10	μΑ
	IGND	All V _{IN} _ = 5V,	+25°C		125	175	
		V_{NO} or $V_{NC} = 0$	C, E, M			300	1

ELECTRICAL CHARACTERISTICS—Single Supply

 $(V+=+15V,\,V-=-15V,\,V_{INL}=0.8V,\,V_{INH}=2.4V,\,T_A=T_{MIN}\,to\,T_{MAX},\,unless\,otherwise\,noted.\,Typical\,values\,are\,at\,T_A=+25^{\circ}C.)\,(Note\,3)$

				• • • • • • • • • • • • • • • • • • • •				, ,	
PARAMETER	SYMBOL	COND	ITIONS	TA	MIN	TYP	MAX	UNITS	
ANALOG SWITCH	1							1	
Fault-Free Analog Signal Range (Note 2)	V _{NO} _, V _{NC} _			C, E, M	0		V+	V	
0014 + 110 - 110		10)/		+25°C		125	200		
COM_ to NO_ or NC_ On-Resistance	Ron	$V_{COM} = 10V,$ $I_{COM} = 1mA$		C, E			250	Ω	
On riesistance		ICOM_ = IIII/(М			300	-	
COM_ to NO_ or NC_		.,		+25°C		4	10		
On-Resistance Match	ΔRON	$V_{COM} = 10V,$ $I_{COM} = 1mA$		C, E			20	Ω	
Between Channels (Note 4)		100 v _ = 1111/1	`	М			30		
NO NO COM OFFICIAL				+25°C	-0.5	0.01	0.5		
NO_, NC_, COM_ Off-Leakage Current (Notes 5, 9)	INO_ (OFF), INC_ (OFF)	$V_{COM} = 10V,$ V_{NO} or $V_{NC} = 10V$	= 12V	C, E	-10		10	nA	
Current (Notes C, C)		VNO_ 01 VNC_ = 12 V		М	-200		200	7	
COM On Lankage Current		\/ 10\/		+25°C	-0.5	0.01	0.5		
COM_ On-Leakage Current (Notes 5, 9)	ICOM_(ON)		OM_(ON) $V_{COM} = 10V$, V_{NO} or $V_{NC} = 1V$ or $12V$	C, E	-20		20	nA	
(110:00 0, 0)		VNO_01 VNC_ = 1V 01 12V		М	-400		400		
FAULT PROTECTION	•			·				•	
Fault-Protected Analog Signal Range (Note 2)	V _{NO} _, V _{NC} _	Applies with power on	MAX4631/ MAX4633	C, E, M	-36		36	V	
			MAX4632	C, E, M	-25		25]	
		Applies with po	ower off	C, E, M	-40		40		

ELECTRICAL CHARACTERISTICS—Single Supply (continued)

 $(V+=+15V, V-=-15V, V_{INL}=0.8V, V_{INH}=2.4V, T_A=T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A=+25^{\circ}C.$) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP	MAX	UNITS
COM_ Output Leakage Current,	Ісом	V _{NO_} or V _{NC_} = ±25V, no connection to "on" channel	C, E	-10		10	nA
Supplies On	.001	(MAX4632 only)	М	-1		1	μΑ
NO_ or NC_ Input Leakage	luo luo	V_{NO} or $V_{NC} = \pm 25V$,	C, E	-100		100	nA
Current, Supplies On	I _{NO} _, I _{NC} _	$V_{COM} = \pm 10V$	М	-10		10	μΑ
NO_ or NC_ Input Leakage Current, Supplies Off	I _{NO_} , I _{NC_}	V_{NO} or V_{NC} = ±40V	C, E	-100 -10	1	100	nA μA
COM_ Output Clamp Current, Supplies On	I _{COM} _	V _{NO_} or V _{NC_} = 25V	+25°C	4	5.5	10	mA
COM_ Output Clamp Resistance, Supplies On	R _{COM} _	V _{NO_} or V _{NC_} = 25V	+25°C		1	2.5	kΩ
LOGIC INPUT		I					1
IN_ Input Logic Voltage High	V _{INH} _		C, E, M	2.4			V
IN_ Input Logic Voltage Low	V _{INL} _		C, E, M			0.8	V
IN_ Input Current Logic		Viv 0.9V or 2.4V	+25°C	-1	0.03	1	μΑ
High or Low	INH_, INL_	V_{IN} = 0.8V or 2.4V	C, E, M	-5		5	μΑ
SWITCH DYNAMIC CHARACTE	RISTICS						
	ton	$V_{COM} = \pm 10V, R_L = 2k\Omega,$ Figure 2	+25°C		140	250	
Turn-On Time			C, E,			300	ns
		<u> </u>	М			500	
T 0"T	toff	$V_{COM} = \pm 10V, R_L = 2k\Omega,$	+25°C		100	200	_
Turn-Off Time		Figure 2	C, E,			250	ns
		101/ 5	М			400	
Break-Before-Make Time Delay (MAX4632 only)	t _{BBM}	V_{COM} = ±10V, R_L = 2k Ω , Figure 3	+25°C	5	40		ns
Charge Injection (Note 6)	Q	C _L = 100pF, Figure 4, NO_ = NC_ = GND, R _S = 0	+25°C		5		рС
NO_, NC_ Off-Capacitance	C _{NC_(OFF)} , C _{NO_(OFF)}	NO_ = NC_ = GND, f = 1MHz, Figure 5	C, E, M		20		pF
COM_ Off-Capacitance	CCOM_(OFF)	COM_ = GND, f = 1MHz, Figure 5	C, E, M		20		pF
COM_ On-Capacitance	C _{COM} (ON)	COM_ = NO_ = NC_ = GND, f = 1MHz, Figure 5	C, E, M		25		pF
Off-Isolation (Note 7)	V _{ISO}	$R_L = 50\Omega$, $C_L = 15pF$, $V_{NO} = V_{NC} = 1V_{RMS}$, f = 1MHz, Figure 6	C, E, M		-62		dB
Channel-to-Channel Crosstalk (Note 8)	V _{CT}	$R_L = 50\Omega$, $C_L = 15pF$, $V_{NO} = V_{NC} = 1V_{RMS}$, $f = 1MHz$, Figure 7	C, E, M		-65		dB

ELECTRICAL CHARACTERISTICS—Single Supply (continued)

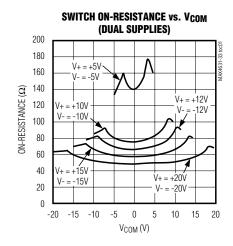
 $(V+ = +15V, V- = -15V, V_{INL} = 0.8V, V_{INH} = 2.4V, T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25$ °C.) (Note 3)

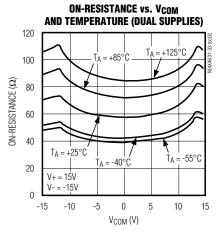
PARAMETER	SYMBOL	CONDITIONS	TA	MIN	TYP	MAX	UNITS
POWER SUPPLY		1					
Power-Supply Range	V+, V-		C, E, M	0		36	V
V+ Supply Current		All V_{IN} = 0 or 5V,	+25°C		165	250	
	l+	V_{NO} or $V_{NC} = 0$	C, E, M			400	μΑ
GND Supply Current	lovio	All V _{IN} _ = 0 or 5V, V _{NO} _ or V _{NC} _ = 0	+25°C		165	250	μA
	IGND		C, E, M			400	¬ μΛ

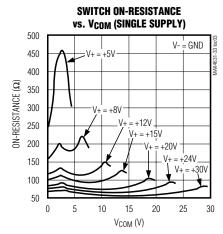
- Note 2: NC_ and NO_ pins are fault protected (see *Electrical Characteristics*). With power applied to V+ or V-, signals on NC_ or NO_ exceeding ±25V (MAX4632) or ±36V (MAX4631/MAX4633) may damage the device. With V+ = V- = 0, signals on NC_ or NO_ exceeding ±40V may damage the device.
- Note 3: The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.
- Note 4: $\Delta R_{ON} = R_{ON(MAX)} R_{ON(MIN)}$
- Note 5: Leakage parameters are 100% tested at maximum rated hot temperature and guaranteed by correlation at +25°C.
- Note 6: Guaranteed by design.
- Note 7: Off-isolation = 20log₁₀ [V_{COM}_ / (V_{NC}_ or V_{NO}_)], V_{COM}_ = output, V_{NC}_ or V_{NO}_ = input to off switch.
- Note 8: Between any two switches.
- Note 9: Leakage testing for single-supply operation is guaranteed by testing with dual supplies.

Typical Operating Characteristics

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

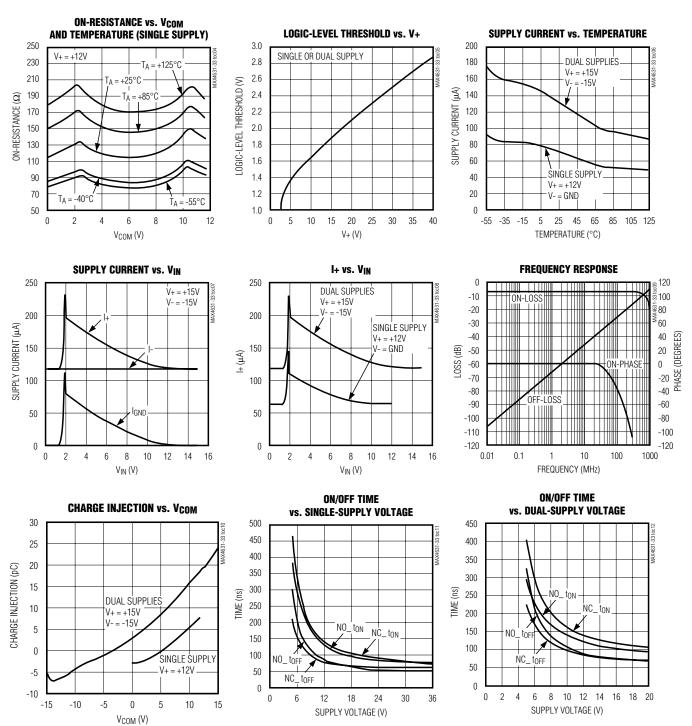






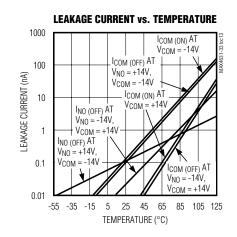
Typical Operating Characteristics (continued)

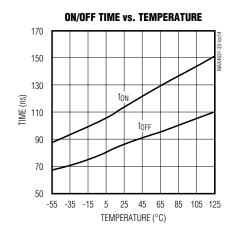
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

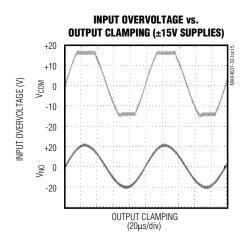


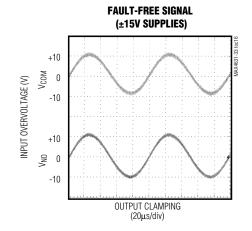
Typical Operating Characteristics (continued)

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$









Pin Description

	PIN		NAME	FUNCTION	
MAX4631	MAX4632	MAX4633	NAME	FUNCTION	
1, 8	1, 8	1, 8	COM1, COM2	Analog Switch Common Terminals	
16, 9	16, 9	16, 9	NO1, NO2	Analog Switch Normally Open Terminals	
15, 10	15, 10	15, 10	IN1, IN2	Logic-Control Digital Inputs	
2–7, 12	2, 7, 12	2, 7, 12	N.C.	No Connection. Not internally connected.	
_	3, 6	3, 6	COM3, COM4	Analog Switch Common Terminals	
_	4, 5	_	NC3, NC4	Analog Switch Normally Closed Terminals	
_	_	4, 5	NO3, NO4	Analog Switch Normally Open Terminals	
11	11	11	V+	Positive Supply Input	
13	13	13	GND	Ground	
14	14	14	V-	Negative Supply Input	

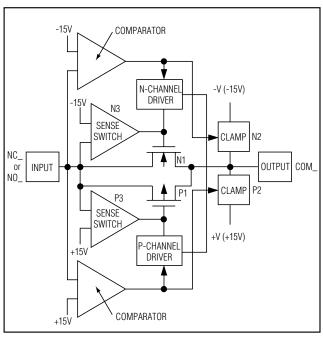


Figure 1. Simplified Internal Structure

Detailed Description

The MAX4631/MAX4632/MAX4633 are fault-protected analog switches with special operation and construction. Traditional fault-protected switches are constructed using three series CMOS devices. This combination produces good fault-protection but fairly high on-resistance when the signals are within 3V of each supply rail. These series devices are not capable of handling signals up to the power-supply rails.

These devices differ considerably from traditional fault-protection switches, with three advantages. First, they are constructed with two parallel FETs, allowing very low on-resistance when the switch is on. Second, they allow signals on the NC_ or NO_ pins that are within or slightly beyond the supply rails to be passed through the switch to the COM_ terminal, allowing rail-to-rail signal operation. Third, when a signal on NC_ or NO_ exceeds the supply rails by about 50mV (a fault condition), the voltage on COM_ is limited to the appropriate polarity supply voltage. Operation is identical for both fault polarities. The fault-protection extends to ± 25 V (MAX4632) or ± 36 V (MAX4631/MAX4633) with power on and ± 40 V with power off.

The MAX4631/MAX4632/MAX4633 have a parallel N-channel and P-channel MOSFET switch configuration with

input voltage sensors. The simplified structure is shown in Figure 1. The parallel N1 and P1 MOSFETs form the switch element. N3 and P3 are sensor elements to sample the input voltage and compare it against the power-supply rails.

During normal operation of a conducting channel, N1 and P1 remain on with a typical 62Ω on-resistance between NO_ (or NC_) and COM_. If the input voltage exceeds either supply rail by about 50mV, the parallel combination switches (N1, P1) are forced off through the driver and sensing circuitry. At the same time, the output (COM_) is clamped to the appropriate supply rail by the clamp circuitry (N2, P2). Two clamp circuits limit the output voltage to the supply voltages.

Pin Compatibility

These switches have identical pinouts to common non-fault-protected CMOS switches (DG401, DG403, DG405). Exercise care in considering them as direct replacements in existing printed circuit boards, since only the NO_ and NC_ pins of each switch are fault protected.

Normal Operation

Two comparators continuously compare the voltage on the NO_ (or NC_) pin with V+ and V- supply voltages (Figure 1). When the signal on NO_ (or NC_) is between V+ and V-, the switch behaves normally, with FETs N1 and P1 turning on and off in response to NO_ (or NC_) signals.

For any voltage between the supply rails, the switch is bidirectional; therefore, COM_ and NO_ (or NC_) are interchangeable. Only NO_ and NC_ can be exposed to overvoltages beyond the supply range and within the specified breakdown limits of the device.

Fault Condition

The MAX4631/MAX4632/MAX4633 protect devices connected to their outputs (COM_) through their unique fault-protection circuitry. When the input voltage is raised 50mV above either supply rail, the internal sense and comparator circuitry (N3 and N-channel driver or P3 and P-channel driver) disconnect the output (COM_) from the input (Figure 1).

If the switch driven above the supply rail has an on state, the clamp circuitry (N2 or P2) connects the output to the appropriate supply rail. Table 1 summarizes the switches' operation under normal and fault conditions.

Table 1. Switch States in Normal and Fault Conditions

POWER SUPPLIES (V+, V-)	INPUT RANGE	NC_	NO_	ОИТРИТ
On	Between Rails	On	Off	NC_
On	Between Rails	Off	On	NO_
On	Between V+ and (+40V - V+)	On	Off	V+
On	Between V+ and (+40V - V+)	Off	On	V+
On	Between V- and (-40V - V-)	On	Off	V-
On	Between V+ and (-40V - V-)	Off	On	V-
Off	Between Rails	Off	Off	Follows the load terminal voltage

Transient Fault Response and Recovery

When a fast rising and falling transient on NO_ (or NC_) exceeds V+ or V-, the output (COM_) follows the input (IN_) to the supply rail with only a few nanoseconds of delay. This delay is due to the switch on-resistance and circuit capacitance to ground. However, when the input transient returns to within the supply rails, there is a longer output recovery time delay. For positive and negative faults, the recovery time is typically 2.5µs. These values depend on the COM_ output resistance and capacitance, and are not production tested or guaranteed. The delays are not dependent on the fault amplitude. Higher COM_ output resistance and capacitance increase recovery times.

Fault-Protection Voltage and Power Off

The maximum fault voltage on the NO_ (or NC_) pins is ±40V when the power is off. For the MAX4631/MAX4633, with ±15V supplies, the highest voltage on NO_ (or NC_) can be +36V, and the lowest voltage on NO (or NC_) can be -36V. For the MAX4632, with ±15V supplies, the highest voltage on NO_ (or NC_) can be +25V, and the lowest voltage on NO_ (or NC_) can be -25V. Exceeding these limits can damage the device.

IN_ Logic-Level Thresholds

The logic-level thresholds are TTL/CMOS compatible when V+ is +15V. Raising V+ increases the threshold slightly; when V+ reaches +25V, the level threshold is about 2.8V—higher than the TTL output high-level minimum of 2.4V, but still compatible with CMOS outputs (see *Typical Operating Characteristics*).

Increasing V- has no effect on the logic-level thresholds, but it does increase the gate-drive voltage to the signal FETs, reducing their on-resistance.

Failure Modes

The MAX4631/MAX4632/MAX4633 are not lightning arrestors or surge protectors. Exceeding the fault-protection voltage limits on NO_ or NC_, even for very short periods, can cause the device to fail. The failure modes may not be obvious, and failure in one switch may or may not affect other switches in the same package.

_Applications Information

Ground

There is no connection between the analog signal paths and GND. The analog signal paths consist of an N-channel and a P-channel MOSFET with their sources and drains paralleled and their gates driven out of phase to V+ and V- by the logic-level translators.

V+ and GND power the internal logic and logic-level translators and set the input logic thresholds. The logic-level translators convert the logic levels to switched V+ and V- signals to drive the analog switch gates. This drive signal is the only connection between the power supplies and the analog signals. GND, IN_, and COM_have ESD-protection diodes to V+ and V-.

Supply-Current Reduction

When the logic signals are driven rail-to-rail from 0 to +12V or -15V to +15V, the supply current reduces to approximately half of the supply current when the logic input levels are at 0 to +5V.

Power Supplies

The MAX4631/MAX4632/MAX4633 operate with bipolar supplies between ±4.5V and ±18V. The V+ and V- supplies need not be symmetrical, but their difference can not exceed the absolute maximum rating of +44V. These devices operate from a single supply between +9V and +36V when V- is connected to GND.

High-Frequency Performance

In 50Ω systems, signal response is reasonably flat up to 30MHz (see *Typical Operating Characteristics*). Above 30MHz, the on-response has several minor peaks that are highly layout dependent. The problem with high-frequency operation is not turning the switch on, but turning it off. The off-state switch acts like a capacitor and passes higher frequencies with less

attenuation. At 10MHz, off-isolation is about -46dB in 50Ω systems, declining (approximately 20dB per decade) as frequency increases. Higher circuit impedance also diminishes off-isolation. Adjacent channel attenuation is about 3dB above that of a bare IC socket and is due entirely to capacitive coupling.

Test Circuits/Timing Diagrams

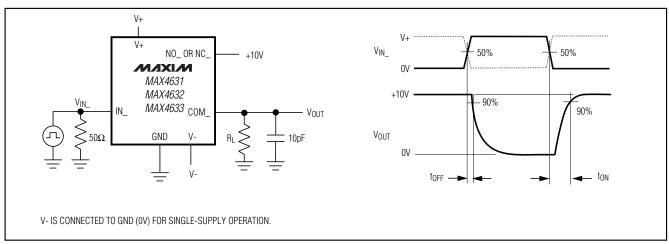


Figure 2. Switch Turn-On/Turn-Off Times

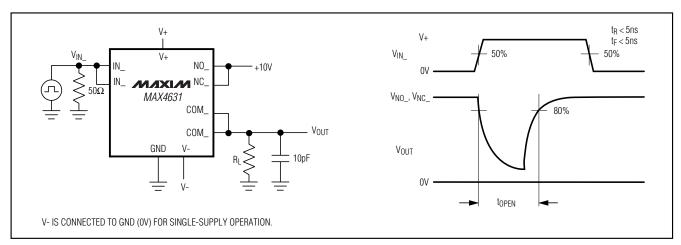


Figure 3. MAX4631 Break-Before-Make Interval

Test Circuits/Timing Diagrams (continued)

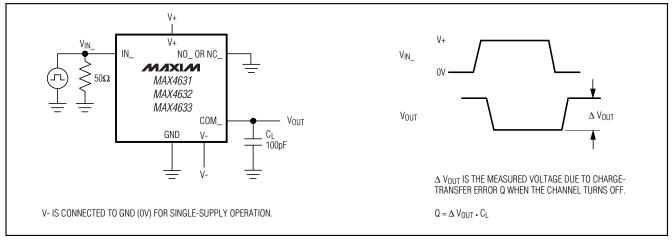


Figure 4. Charge Injection

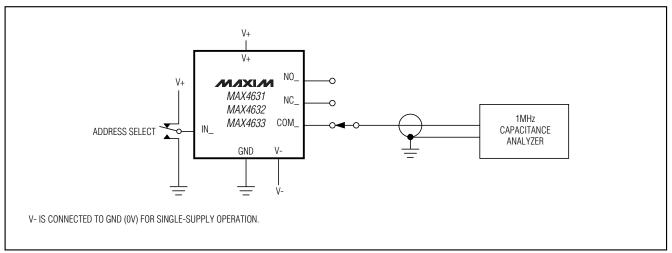


Figure 5. COM_, NO_, and NC_ Capacitance

Test Circuits/Timing Diagrams (continued)

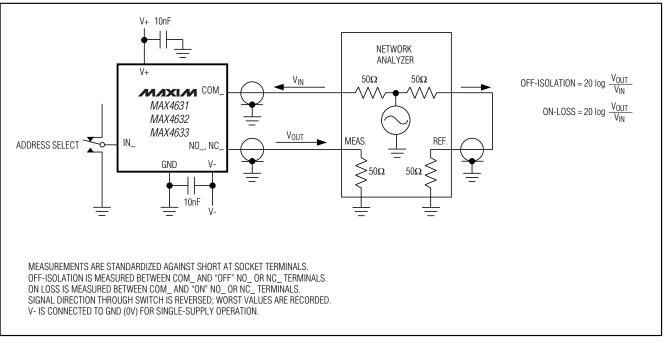


Figure 6. Frequency Response and Off-Isolation

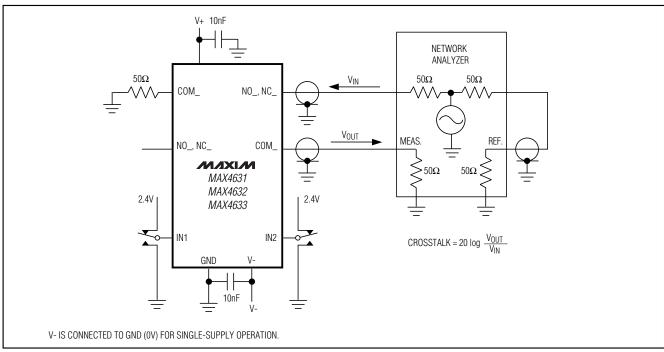
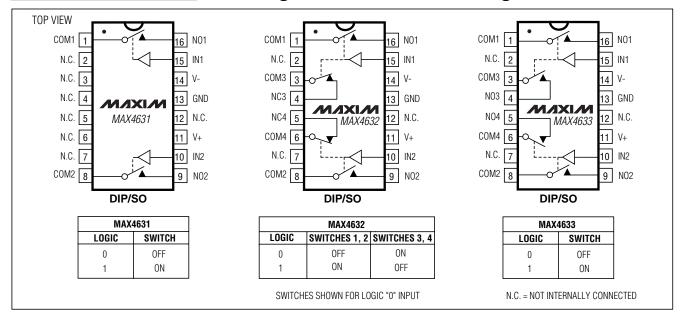


Figure 7. Crosstalk

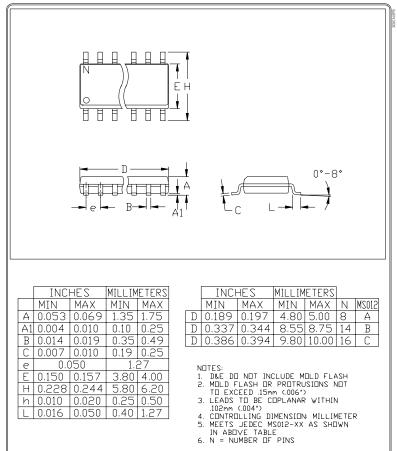
Pin Configurations/Functional Diagrams/Truth Tables



Chip Information

TRANSISTOR COUNT: 223

Package Information

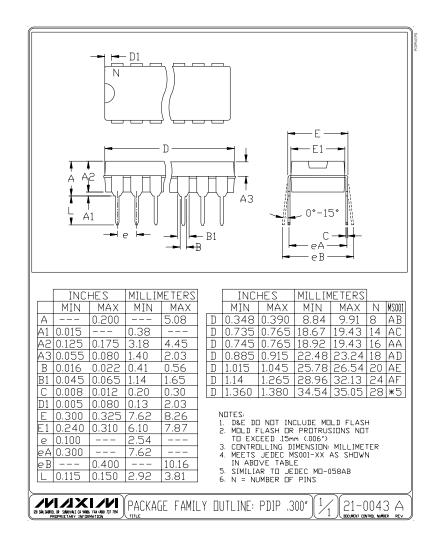


H 0.228 0.244 5.80 6.20 h 0.010 0.020 0.25 0.50 L 0.016 0.050 0.40 1.27

PACKAGE FAMILY DUTLINE: SDIC .150" 1



Package Information (continued)



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